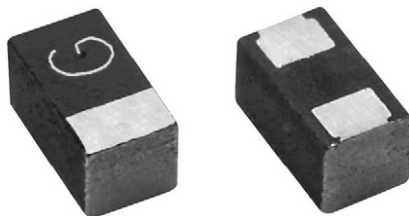


Solid Tantalum Chip Capacitors

MICROTAN® DLA Approved, Leadframeless Molded



FEATURES

- High reliability solid surface mount tantalum capacitors
- Terminations: gold plated; tin / lead solder plated
- Reliability grade: Weibull B per MIL-PRF-55365
- Low DCL for extended battery life
- Small sizes for space constrained applications
- L-shaped terminations for superior board mounting
- The molding compound has been selected to meet the requirements of UL 94 V-0 and outgassing requirements of ASTM E-595

PERFORMANCE / ELECTRICAL CHARACTERISTICS

www.vishay.com/doc?40170

Operating Temperature: -55 °C to +125 °C
(above 85 °C, voltage derating is required)

Capacitance Range: 1 µF to 47 µF

Capacitance Tolerance: ± 10 %; ± 20 %

Voltage Range: 6.3 V_{DC} to 40 V_{DC}

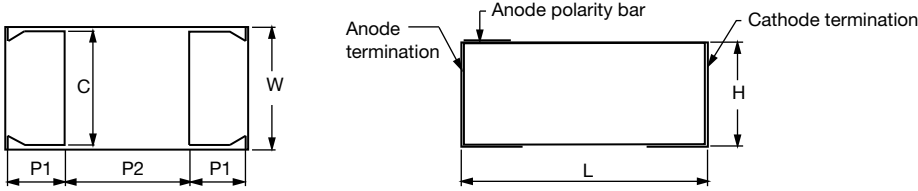
ORDERING INFORMATION

| 11020- DRAWING NUMBER | 001 DASH NUMBER | K CAPACITANCE TOLERANCE | E TERMINATION FINISH | B RELIABILITY GRADE (% per 1000 h) | A ⁽¹⁾ SURGE CURRENT OPTION | /HR PACKAGING |
|-----------------------------|-----------------------|-------------------------------|--------------------------------------|--|--|---|
| | | K = ± 10 % M = ± 20 % | A = gold plated E = solder plated | B = 0.1 | A = 10 cycles at +25 °C B = 10 cycles at -55 °C / +85 °C C = 10 cycles at -55 °C / +85 °C (before Weibull grading) Z = no surge current | Blank = full 7" reel /HR = half 7" reel /PR = partial 7" reel |

Note

⁽¹⁾ Surge current testing is not available for case code M


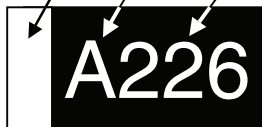


DIMENSIONS in inches [millimeters]

|  | | | | | | |
|--|--------------------------------|--------------------------------|-----------------|-------------------------------|---------------------------|-------------------------------|
| CASE CODE | L | W | H (Max.) | P1 | P2 (REF.) | C |
| M | 0.067 ± 0.002 [1.7 ± 0.05] | 0.037 ± 0.002 [0.95 ± 0.05] | 0.039 [0.99] | 0.020 ± 0.004 [0.5 ± 0.1] | 0.026 min. [0.65 min.] | 0.024 ± 0.004 [0.6 ± 0.1] |
| W | 0.081 ± 0.006 [2.06 ± 0.15] | 0.053 ± 0.006 [1.35 ± 0.15] | 0.047 [1.2] | 0.020 ± 0.004 [0.5 ± 0.1] | 0.028 min. [0.71 min.] | 0.035 ± 0.004 [0.9 ± 0.1] |
| R | 0.081 ± 0.006 [2.06 ± 0.15] | 0.053 ± 0.006 [1.35 ± 0.15] | 0.062 [1.57] | 0.020 ± 0.004 [0.5 ± 0.1] | 0.028 min. [0.71 min.] | 0.035 ± 0.004 [0.9 ± 0.1] |
| P | 0.096 ± 0.006 [2.44 ± 0.15] | 0.059 ± 0.006 [1.50 ± 0.15] | 0.049 [1.25] | 0.020 ± 0.004 [0.5 ± 0.1] | 0.043 min. [1.10 min.] | 0.035 ± 0.004 [0.90 ± 0.1] |
| A | 0.126 ± 0.008 [3.2 ± 0.2] | 0.063 ± 0.008 [1.6 ± 0.2] | 0.071 [1.8] | 0.031 ± 0.004 [0.8 ± 0.1] | 0.063 min. [1.60 min.] | 0.047 ± 0.004 [1.2 ± 0.1] |
| N | 0.138 ± 0.004 [3.5 ± 0.1] | 0.110 ± 0.004 [2.8 ± 0.1] | 0.047 [1.2] | 0.034 ± 0.004 [0.85 ± 0.1] | 0.065 min. [1.65 min.] | 0.094 ± 0.004 [2.4 ± 0.1] |
| T | 0.138 ± 0.004 [3.5 ± 0.1] | 0.110 ± 0.004 [2.8 ± 0.1] | 0.062 [1.57] | 0.034 ± 0.004 [0.85 ± 0.1] | 0.065 min. [1.65 min.] | 0.094 ± 0.004 [2.4 ± 0.1] |

RATINGS AND CASE CODES

| μF | 6.3 V | 10 V | 16 V | 20 V | 25 V | 40 V |
|---------------|-------|------|-------|------|------|------|
| 1.0 | | M | M | W | R | P |
| 2.2 | | | M | | | |
| 3.3 | | M | | R | | |
| 4.7 | | M | | | P | |
| 7.5 | | W | | N | | |
| 10 | M | R | R / A | A | | |
| 15 | M | R | | | | |
| 22 | | A | | | | |
| 47 | | T | | | | |

MARKING

| M-Case | | VOLTAGE CODE | | CAPACITANCE CODE | | P, R, W-Case | |
|--|---|---------------------|------|-------------------------|----------|--|---|
|  |  | V | CODE | CAP, μF | CODE |  |  |
| | | 6.3 | J | 1.0 | A | | |
| | | 10 | A | 3.3 | N | | |
| | | 16 | C | 4.7 | S | | |
| | | 20 | D | 7.5 | X | | |
| | | 25 | E | 10 | α | | |
| | | 40 | g | 15 | e | | |
| | | | | 22 | j | | |
| | | | | 47 | s | | |



| STANDARD RATINGS | | | | | | | | | |
|---|--------------|---------------------|--------------|--------|---------|------------|-------------------|--------|---|
| CAPACITANCE (μF) | CASE CODE | PART NUMBER | MAX. DCL, μA | | | MAX. DF, % | | | MAX. ESR AT +25 °C 100 kHz (ω) |
| | | | +25 °C | +85 °C | +125 °C | +25 °C | +85 °C +125 °C | -55 °C | |
| 6.3 V _{DC} AT +85 °C; 4 V _{DC} AT +125 °C, 8 V _{DC} SURGE AT +85 °C | | | | | | | | | |
| 10 | M | 11020-001(1)(2)BZ | 0.32 | 3.2 | 3.8 | 8 | 16 | 12 | 5.0 |
| 15 | M | 11020-002(1)(2)BZ | 0.47 | 4.7 | 5.6 | 8 | 16 | 12 | 5.0 |
| 10 V _{DC} AT +85 °C; 7 V _{DC} AT +125 °C, 13 V _{DC} SURGE AT +85 °C | | | | | | | | | |
| 1.0 | M | 11020-005(1)(2)BZ | 0.20 | 2.0 | 2.4 | 6 | 12 | 9 | 12.0 |
| 3.3 | M | 11020-006(1)(2)BZ | 0.20 | 2.0 | 2.4 | 8 | 16 | 12 | 6.0 |
| 4.7 | M | 11020-007(1)(2)BZ | 0.24 | 2.4 | 2.9 | 8 | 16 | 12 | 6.0 |
| 7.5 | W | 11020-008(1)(2)B(3) | 0.38 | 3.8 | 4.6 | 8 | 16 | 12 | 8.0 |
| 10 | R | 11020-009(1)(2)B(3) | 0.50 | 5.0 | 6.0 | 8 | 16 | 12 | 6.0 |
| 15 | R | 11020-024(1)(2)B(3) | 0.75 | 7.5 | 9.0 | 8 | 16 | 12 | 5.0 |
| 22 | A | 11020-010(1)(2)B(3) | 1.10 | 11.0 | 13.2 | 8 | 16 | 12 | 1.5 |
| 47 | T | 11020-011(1)(2)B(3) | 2.35 | 23.5 | 28.2 | 8 | 16 | 12 | 1.0 |
| 16 V _{DC} AT +85 °C; 10 V _{DC} AT +125 °C, 20 V _{DC} SURGE AT +85 °C | | | | | | | | | |
| 1.0 | M | 11020-013(1)(2)B(3) | 0.20 | 2.0 | 2.4 | 6 | 12 | 9 | 12.0 |
| 2.2 | M | 11020-025(1)(2)BZ | 0.20 | 2.0 | 2.4 | 8 | 16 | 12 | 10.0 |
| 10 | R | 11020-014(1)(2)B(3) | 0.80 | 8.0 | 9.6 | 8 | 16 | 12 | 6.0 |
| 10 | A | 11020-015(1)(2)B(3) | 0.80 | 8.0 | 9.6 | 8 | 16 | 12 | 3.0 |
| 20 V _{DC} AT +85 °C; 13 V _{DC} AT +125 °C, 26 V _{DC} SURGE AT +85 °C | | | | | | | | | |
| 1.0 | W | 11020-016(1)(2)B(3) | 0.20 | 2.0 | 2.4 | 8 | 16 | 12 | 8.0 |
| 3.3 | R | 11020-017(1)(2)B(3) | 0.33 | 3.3 | 4.0 | 8 | 16 | 12 | 8.0 |
| 7.5 | N | 11020-018(1)(2)B(3) | 0.75 | 7.5 | 9.0 | 8 | 16 | 12 | 8.0 |
| 10 | A | 11020-019(1)(2)B(3) | 1.00 | 10.0 | 12.0 | 8 | 16 | 12 | 3.0 |
| 25 V _{DC} AT +85 °C; 17 V _{DC} AT +125 °C, 32 V _{DC} SURGE AT +85 °C | | | | | | | | | |
| 1.0 | R | 11020-020(1)(2)B(3) | 0.20 | 2.0 | 2.4 | 6 | 12 | 9 | 10.0 |
| 4.7 | P | 11020-021(1)(2)B(3) | 0.59 | 5.9 | 7.1 | 6 | 12 | 9 | 6.0 |
| 40 V _{DC} AT +85 °C; 27 V _{DC} AT +125 °C, 52 V _{DC} SURGE AT +85 °C | | | | | | | | | |
| 1.0 | P | 11020-023(1)(2)B(3) | 0.20 | 2.0 | 2.4 | 8 | 16 | 12 | 10.0 |

Note

- Part number definitions:
 - Capacitance tolerance: K, M
 - Termination: E, A
 - Surge current options: A, B, C, Z

| POWER DISSIPATION | |
|-------------------|--|
| CASE CODE | MAXIMUM PERMISSIBLE POWER DISSIPATION AT +25 °C (W) IN FREE AIR |
| M | 0.025 |
| W | 0.040 |
| R | 0.045 |
| P | 0.045 |
| A | 0.075 |
| N | 0.075 |
| T | 0.084 |

**STANDARD PACKAGING QUANTITY**

| CASE CODE | UNITS PER REEL | | |
|-----------|----------------|--------------------|-----------------------|
| | 7" FULL REEL | 7" HALF REEL (/HR) | 7" PARTIAL REEL (/PR) |
| M | 4000 | 2000 | 300 |
| W | 2500 | 1250 | 300 |
| R | 2500 | 1250 | 300 |
| P | 3000 | 1500 | 300 |
| A | 2000 | 1000 | 300 |
| N | 2500 | 1250 | 300 |
| T | 2500 | 1250 | 300 |

PRODUCT INFORMATION

| | |
|--|--|
| Micro Guide | www.vishay.com/doc?40115 |
| Pad Dimensions | |
| Packaging Dimensions | |
| Moisture Sensitivity | www.vishay.com/doc?40135 |
| Typical Performance Characteristics | www.vishay.com/doc?40170 |
| Solid Tantalum Capacitors (With MnO ₂ Electrolyte) Voltage Derating | www.vishay.com/doc?40246 |
| SELECTOR GUIDES | |
| Solid Tantalum Selector Guide | www.vishay.com/doc?49053 |
| Solid Tantalum Chip Capacitors | www.vishay.com/doc?40091 |
| FAQ | |
| Frequently Asked Questions | www.vishay.com/doc?40110 |



Guide for Leadframeless Molded Tantalum Capacitors

INTRODUCTION

Tantalum electrolytic capacitors are the preferred choice in applications where volumetric efficiency, stable electrical parameters, high reliability, and long service life are primary considerations. The stability and resistance to elevated temperatures of the tantalum / tantalum oxide / manganese dioxide system make solid tantalum capacitors an appropriate choice for today's surface mount assembly technology.

Vishay Sprague has been a pioneer and leader in this field, producing a large variety of tantalum capacitor types for consumer, industrial, automotive, military, and aerospace electronic applications.

Tantalum is not found in its pure state. Rather, it is commonly found in a number of oxide minerals, often in combination with Columbium ore. This combination is known as "tantalite" when its contents are more than one-half tantalum. Important sources of tantalite include Australia, Brazil, Canada, China, and several African countries. Synthetic tantalite concentrates produced from tin slags in Thailand, Malaysia, and Brazil are also a significant raw material for tantalum production.

Electronic applications, and particularly capacitors, consume the largest share of world tantalum production. Other important applications for tantalum include cutting tools (tantalum carbide), high temperature super alloys, chemical processing equipment, medical implants, and military ordnance.

Vishay Sprague is a major user of tantalum materials in the form of powder and wire for capacitor elements and rod and sheet for high temperature vacuum processing.

THE BASICS OF TANTALUM CAPACITORS

Most metals form crystalline oxides which are non-protecting, such as rust on iron or black oxide on copper. A few metals form dense, stable, tightly adhering, electrically insulating oxides. These are the so-called "valve" metals and include titanium, zirconium, niobium, tantalum, hafnium, and aluminum. Only a few of these permit the accurate control of oxide thickness by electrochemical means. Of these, the most valuable for the electronics industry are aluminum and tantalum.

Capacitors are basic to all kinds of electrical equipment, from radios and television sets to missile controls and automobile ignitions. Their function is to store an electrical charge for later use.

Capacitors consist of two conducting surfaces, usually metal plates, whose function is to conduct electricity. They are separated by an insulating material or dielectric. The dielectric used in all tantalum electrolytic capacitors is tantalum pentoxide.

Tantalum pentoxide compound possesses high-dielectric strength and a high-dielectric constant. As capacitors are being manufactured, a film of tantalum pentoxide is applied to their electrodes by means of an electrolytic process. The film is applied in various thicknesses and at various voltages and although transparent to begin with, it takes on different colors as light refracts through it. This coloring occurs on the tantalum electrodes of all types of tantalum capacitors.

Rating for rating, tantalum capacitors tend to have as much as three times better capacitance / volume efficiency than aluminum electrolytic capacitors. An approximation of the capacitance / volume efficiency of other types of capacitors may be inferred from the following table, which shows the dielectric constant ranges of the various materials used in each type. Note that tantalum pentoxide has a dielectric constant of 26, some three times greater than that of aluminum oxide. This, in addition to the fact that extremely thin films can be deposited during the electrolytic process mentioned earlier, makes the tantalum capacitor extremely efficient with respect to the number of microfarads available per unit volume. The capacitance of any capacitor is determined by the surface area of the two conducting plates, the distance between the plates, and the dielectric constant of the insulating material between the plates.

COMPARISON OF CAPACITOR DIELECTRIC CONSTANTS

| DIELECTRIC | ϵ DIELECTRIC CONSTANT |
|--------------------|-----------------------------------|
| Air or Vacuum | 1.0 |
| Paper | 2.0 to 6.0 |
| Plastic | 2.1 to 6.0 |
| Mineral Oil | 2.2 to 2.3 |
| Silicone Oil | 2.7 to 2.8 |
| Quartz | 3.8 to 4.4 |
| Glass | 4.8 to 8.0 |
| Porcelain | 5.1 to 5.9 |
| Mica | 5.4 to 8.7 |
| Aluminum Oxide | 8.4 |
| Tantalum Pentoxide | 26 |
| Ceramic | 12 to 400K |

In the tantalum electrolytic capacitor, the distance between the plates is very small since it is only the thickness of the tantalum pentoxide film. As the dielectric constant of the tantalum pentoxide is high, the capacitance of a tantalum capacitor is high if the area of the plates is large:

$$C = \frac{\epsilon A}{t}$$

where

C = capacitance

ϵ = dielectric constant

A = surface area of the dielectric

t = thickness of the dielectric

Tantalum capacitors contain either liquid or solid electrolytes. In solid electrolyte capacitors, a dry material (manganese dioxide) forms the cathode plate. A tantalum lead is embedded in or welded to the pellet, which is in turn connected to a termination or lead wire. The drawings show the construction details of the surface mount types of tantalum capacitors shown in this catalog.

SOLID ELECTROLYTE TANTALUM CAPACITORS

Solid electrolyte capacitors contain manganese dioxide, which is formed on the tantalum pentoxide dielectric layer by impregnating the pellet with a solution of manganous nitrate. The pellet is then heated in an oven, and the manganous nitrate is converted to manganese dioxide.

The pellet is next coated with graphite, followed by a layer of metallic silver, which provides a conductive surface between the pellet and the leadframe.

Molded chip tantalum capacitor encases the element in plastic resins, such as epoxy materials. The molding compound has been selected to meet the requirements of UL 94 V-0 and outgassing requirements of ASTM E-595. After assembly, the capacitors are tested and inspected to assure long life and reliability. It offers excellent reliability and high stability for consumer and commercial electronics with the added feature of low cost.

Surface mount designs of "Solid Tantalum" capacitors use lead frames or lead frameless designs as shown in the accompanying drawings.

TANTALUM CAPACITORS FOR ALL DESIGN CONSIDERATIONS

Solid electrolyte designs are the least expensive for a given rating and are used in many applications where their very small size for a given unit of capacitance is of importance. They will typically withstand up to about 10 % of the rated DC working voltage in a reverse direction. Also important are their good low temperature performance characteristics and freedom from corrosive electrolytes.

Vishay Sprague patented the original solid electrolyte capacitors and was the first to market them in 1956. Vishay Sprague has the broadest line of tantalum capacitors and has continued its position of leadership in this field. Data sheets covering the various types and styles of Vishay Sprague capacitors for consumer and entertainment electronics, industry, and military applications are available where detailed performance characteristics must be specified.

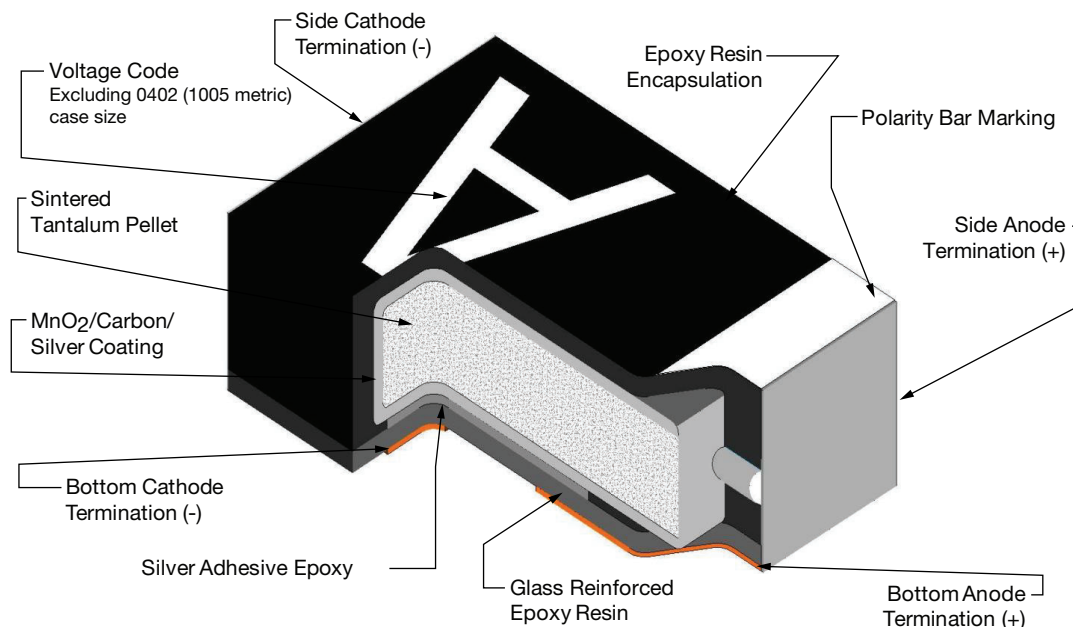
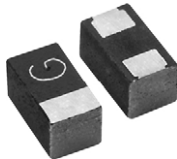
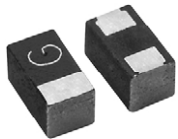
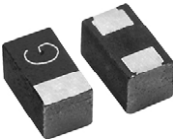
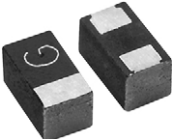
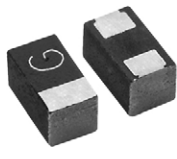
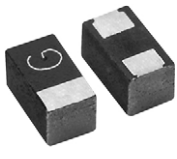
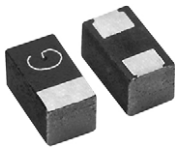
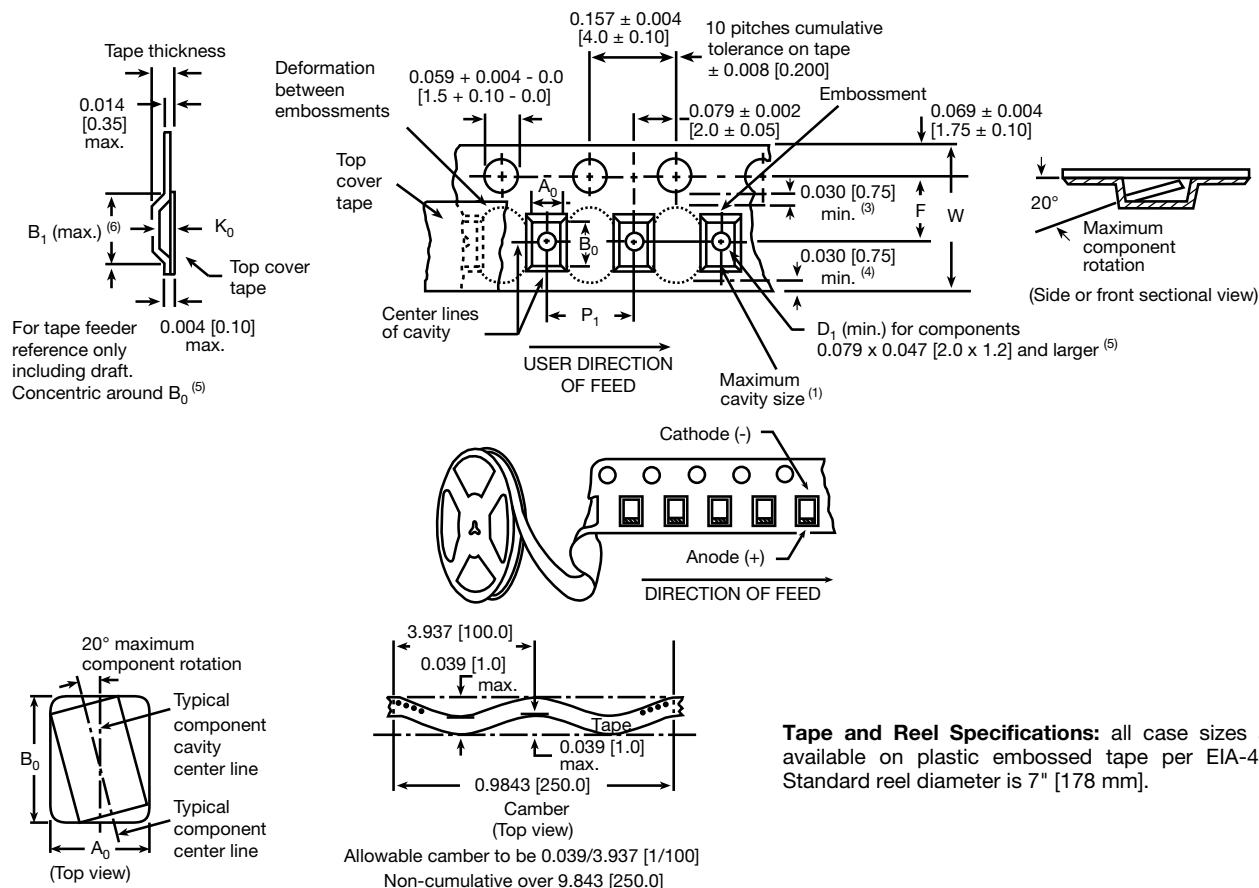


Fig. 1 - Leadframeless Molded Capacitors, All Types

| SOLID TANTALUM CAPACITORS - LEADFRAMELESS MOLDED | | | | |
|---|--|--|--|--|
| SERIES | TL8 | 298D | 298W | TR8 |
| PRODUCT IMAGE |  |  |  |  |
| TYPE | Solid tantalum leadframeless molded chip capacitors | | | |
| FEATURES | Small size including 0603 and 0402 foot print | | | |
| | Ultra low profile | Industrial grade | Industrial grade, extended range | Low ESR |
| TEMPERATURE RANGE | Operating Temperature: -55 °C to +125 °C (above 40 °C, voltage derating is required) | Operating Temperature: -55 °C to +125 °C (above 85 °C, voltage derating is required) | Operating Temperature: -55 °C to +125 °C (above 40 °C, voltage derating is required) | Operating Temperature: -55 °C to +125 °C (above 85 °C, voltage derating is required) |
| CAPACITANCE RANGE | 0.68 μ F to 220 μ F | 0.33 μ F to 220 μ F | 2.2 μ F to 220 μ F | 1 μ F to 220 μ F |
| VOLTAGE RANGE | 4 V to 25 V | 2.5 V to 50 V | 4 V to 16 V | 2.5 V to 25 V |
| CAPACITANCE TOLERANCE | $\pm 20\%$, $\pm 10\%$ | | | |
| DISSIPATION FACTOR | 6 % to 80 % | 6 % to 80 % | 30 % to 80 % | 6 % to 80 % |
| CASE CODES | W9, A0, B0 | K, M, R, P, Q, A, S, B | K, M, Q | M, R, P, Q, A, B |
| TERMINATION | 100 % tin | 100 % tin or gold plated | | |

| SOLID TANTALUM CAPACITORS - LEADFRAMELESS MOLDED | | | |
|---|--|--|---|
| SERIES | TP8 | TM8 | DLA 11020 |
| PRODUCT IMAGE |  |  |  |
| TYPE | Solid tantalum leadframeless molded chip capacitors | | |
| FEATURES | Small size including 0603 and 0402 foot print | | |
| | High performance, automotive grade | High reliability | High reliability, DLA approved |
| TEMPERATURE RANGE | Operating Temperature: -55 °C to +125 °C (above 85 °C, voltage derating is required) | | |
| CAPACITANCE RANGE | 1 μ F to 100 μ F | 0.68 μ F to 47 μ F | 1 μ F to 47 μ F |
| VOLTAGE RANGE | 6.3 V to 40 V | 2 V to 40 V | 6.3 V to 40 V |
| CAPACITANCE TOLERANCE | $\pm 20\%$, $\pm 10\%$ | | |
| DISSIPATION FACTOR | 6 % to 30 % | 6 % to 20 % | 6 % to 8 % |
| CASE CODES | M, W, R, P, A, N, T, B | K, M, G, W, R, P, A, N, T | M, W, R, P, A, N, T |
| TERMINATION | 100 % tin | Tin / lead solder plated, 100 % tin and gold plated | Tin / lead solder plated or gold plated |

PLASTIC TAPE AND REEL PACKAGING in inches [millimeters]



Tape and Reel Specifications: all case sizes are available on plastic embossed tape per EIA-481. Standard reel diameter is 7" [178 mm].

Notes

- Metric dimensions will govern. Dimensions in inches are rounded and for reference only
- (1) A_0 , B_0 , K_0 , are determined by the maximum dimensions to the ends of the terminals extending from the component body and / or the body dimensions of the component. The clearance between the ends of the terminals or body of the component to the sides and depth of the cavity (A_0 , B_0 , K_0) must be within 0.002" (0.05 mm) minimum and 0.020" (0.50 mm) maximum. The clearance allowed must also prevent rotation of the component within the cavity of not more than 20°
- (2) Tape with components shall pass around radius "R" without damage. The minimum trailer length may require additional length to provide "R" minimum for 12 mm embossed tape for reels with hub diameters approaching N minimum
- (3) This dimension is the flat area from the edge of the sprocket hole to either outward deformation of the carrier tape between the embossed cavities or to the edge of the cavity whichever is less
- (4) This dimension is the flat area from the edge of the carrier tape opposite the sprocket holes to either the outward deformation of the carrier tape between the embossed cavity or to the edge of the cavity whichever is less
- (5) The embossed hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of embossment location shall be applied independent of each other
- (6) B_1 dimension is a reference dimension tape feeder clearance only

CARRIER TAPE DIMENSIONS in inches [millimeters] FOR 298D, 298W, TR8, TP8, TL8

| CASE CODE | TAPE SIZE | B_1 (MAX.) ⁽¹⁾ | D_1 (MIN.) | F | K_0 (MAX.) | P_1 | W |
|------------------|-----------|-----------------------------|--------------|-------------|--------------|-------------|--------------|
| M ⁽²⁾ | 8 mm | 0.075 [1.91] | 0.02 [0.5] | 0.138 [3.5] | 0.043 [1.10] | 0.157 [4.0] | 0.315 [8.0] |
| W | 8 mm | 0.112 [2.85] | 0.039 [1.0] | 0.138 [3.5] | 0.053 [1.35] | 0.157 [4.0] | 0.315 [8.0] |
| R | 8 mm | 0.098 [2.46] | 0.039 [1.0] | 0.138 [3.5] | 0.066 [1.71] | 0.157 [4.0] | 0.315 [8.0] |
| P | 8 mm | 0.108 [2.75] | 0.02 [0.5] | 0.138 [3.5] | 0.054 [1.37] | 0.157 [4.0] | 0.315 [8.0] |
| A | 8 mm | 0.153 [3.90] | 0.039 [1.0] | 0.138 [3.5] | 0.078 [2.00] | 0.157 [4.0] | 0.315 [8.0] |
| A0, Q | 8 mm | - | 0.02 [0.5] | 0.138 [3.5] | 0.049 [1.25] | 0.157 [4.0] | 0.315 [8.0] |
| B | 8 mm | 0.157 [4.0] | 0.039 [1.0] | 0.138 [3.5] | 0.087 [2.22] | 0.157 [4.0] | 0.315 [8.0] |
| W9, S | 8 mm | 0.126 [3.20] | 0.029 [0.75] | 0.138 [3.5] | 0.045 [1.15] | 0.157 [4.0] | 0.315 [8.0] |
| B0 | 12 mm | 0.181 [4.61] | 0.059 [1.5] | 0.217 [5.5] | 0.049 [1.25] | 0.157 [4.0] | 0.472 [12.0] |

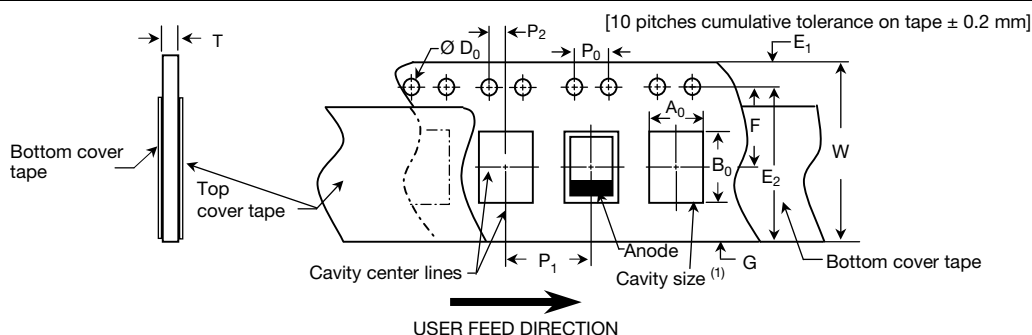
Notes

- (1) For reference only
- (2) Packaging of M case in plastic tape is available per request

CARRIER TAPE DIMENSIONS in inches [millimeters] **FOR TM8**

| CASE CODE | TAPE SIZE | B ₁ (MAX.) ⁽¹⁾ | D ₁ (MIN.) | F | K ₀ (MAX.) | P ₁ | W |
|-----------|-----------|--------------------------------------|-----------------------|-------------|-----------------------|----------------|--------------|
| M | 8 mm | 0.075 [1.91] | 0.02 [0.5] | 0.138 [3.5] | 0.043 [1.10] | 0.157 [4.0] | 0.315 [8.0] |
| G | 8 mm | 0.077 [1.96] | 0.02 [0.5] | 0.138 [3.5] | 0.051 [1.30] | 0.157 [4.0] | 0.315 [8.0] |
| W | 8 mm | 0.112 [2.85] | 0.039 [1.0] | 0.138 [3.5] | 0.053 [1.35] | 0.157 [4.0] | 0.315 [8.0] |
| R | 8 mm | 0.098 [2.46] | 0.039 [1.0] | 0.138 [3.5] | 0.066 [1.71] | 0.157 [4.0] | 0.315 [8.0] |
| P | 8 mm | 0.108 [2.75] | 0.02 [0.5] | 0.138 [3.5] | 0.054 [1.37] | 0.157 [4.0] | 0.315 [8.0] |
| A | 8 mm | 0.153 [3.90] | 0.039 [1.0] | 0.138 [3.5] | 0.078 [2.00] | 0.157 [4.0] | 0.315 [8.0] |
| N | 12 mm | 0.154 [3.90] | 0.059 [1.5] | 0.216 [5.5] | 0.051 [1.30] | 0.157 [4.0] | 0.472 [12.0] |
| T | 12 mm | 0.154 [3.90] | 0.059 [1.5] | 0.216 [5.5] | 0.067 [1.70] | 0.157 [4.0] | 0.472 [12.0] |

Notes
⁽¹⁾ For reference only

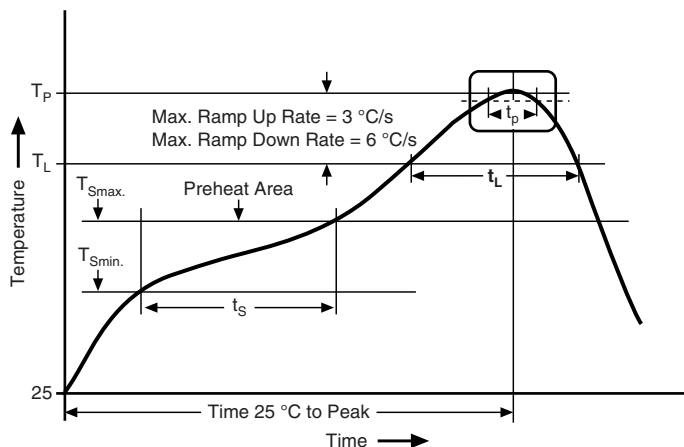
PAPER TAPE AND REEL PACKAGING in inches [millimeters]
FOR 298D, 298W, TR8, TP8, TL8, TM8 (K case only)


| CASE SIZE | TAPE SIZE | A ₀ | B ₀ | D ₀ | P ₀ | P ₁ | P ₂ | E | F | W | T |
|-----------|-----------|--------------------------------|--------------------------------|-----------------------------|------------------------------|------------------------------|-------------------------------|-------------------------------|--------------------------------|------------------------------|--------------------------------|
| K | 8 mm | 0.033 ± 0.002 [0.85 ± 0.05] | 0.053 ± 0.002 [1.35 ± 0.05] | 0.06 ± 0.004 [1.5 ± 0.1] | 0.157 ± 0.004 [4.0 ± 0.1] | 0.078 ± 0.004 [2.0 ± 0.1] | 0.079 ± 0.002 [2.0 ± 0.05] | 0.069 ± 0.004 [1.75 ± 0.1] | 0.0138 ± 0.002 [3.5 ± 0.05] | 0.315 ± 0.008 [8.0 ± 0.2] | 0.03 ± 0.002 [0.75 ± 0.05] |
| M | 8 mm | 0.041 ± 0.002 [1.05 ± 0.05] | 0.071 ± 0.002 [1.8 ± 0.05] | 0.06 ± 0.004 [1.5 ± 0.1] | 0.157 ± 0.004 [4.0 ± 0.1] | 0.157 ± 0.004 [4.0 ± 0.1] | 0.079 ± 0.002 [2.0 ± 0.05] | 0.069 ± 0.004 [1.75 ± 0.1] | 0.0138 ± 0.002 [3.5 ± 0.05] | 0.315 ± 0.008 [8.0 ± 0.2] | 0.037 ± 0.002 [0.95 ± 0.05] |

Note
⁽¹⁾ A₀, B₀ are determined by the maximum dimensions to the ends of the terminals extending from the component body and / or the body dimensions of the component. The clearance between the ends of the terminals or body of the component to the sides and depth of the cavity (A₀, B₀) must be within 0.002" (0.05 mm) minimum and 0.020" (0.50 mm) maximum. The clearance allowed must also prevent rotation of the component within the cavity of not more than 20°

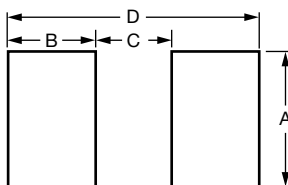
RECOMMENDED REFLOW PROFILES

Capacitors should withstand reflow profile as per J-STD-020 standard, three cycles.



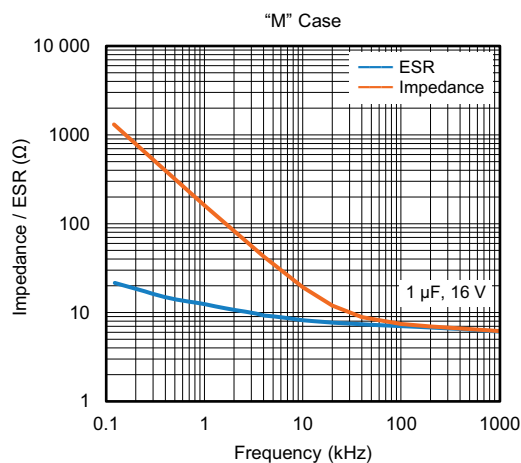
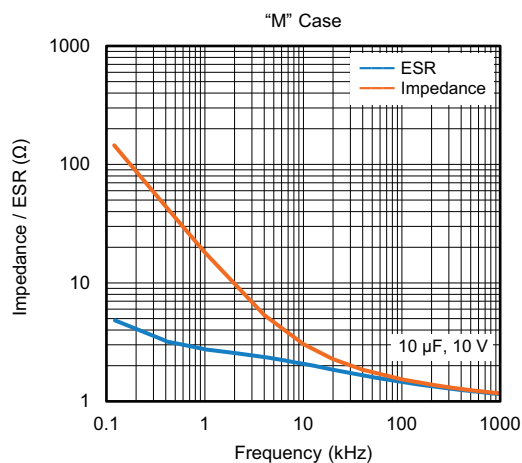
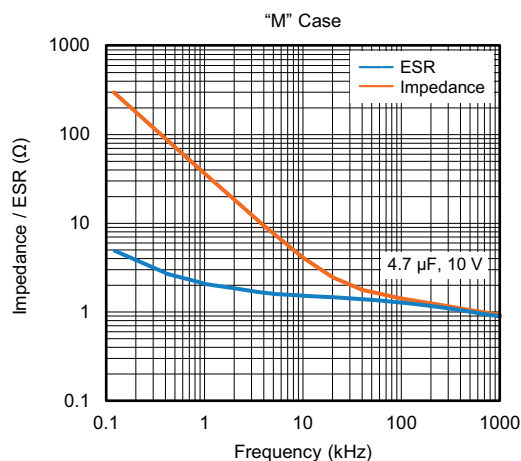
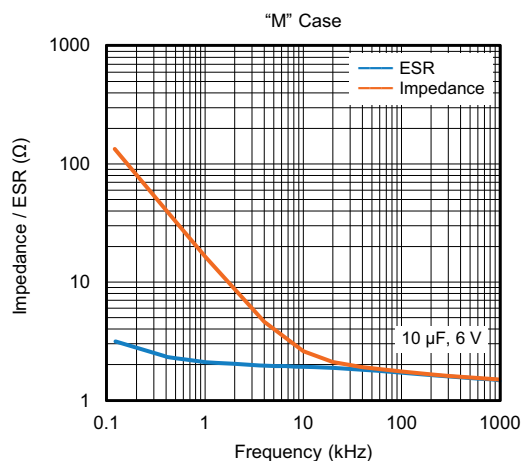
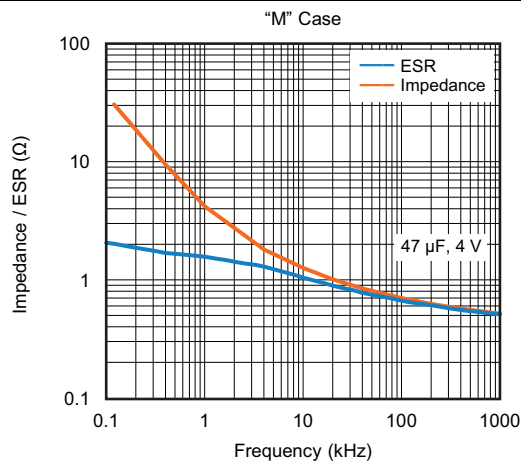
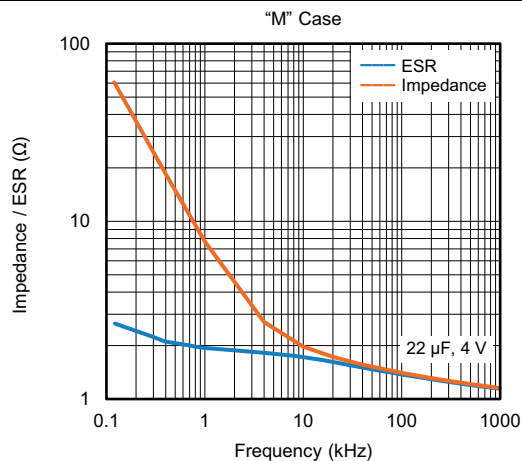
| PROFILE FEATURE | SnPb EUTECTIC ASSEMBLY | LEAD (Pb)-FREE ASSEMBLY |
|---|------------------------|-------------------------|
| PREHEAT AND SOAK | | |
| Temperature min. ($T_{Smin.}$) | 100 °C | 150 °C |
| Temperature max. ($T_{Smax.}$) | 150 °C | 200 °C |
| Time (t_S) from ($T_{Smin.}$ to $T_{Smax.}$) | 60 s to 90 s | 60 s to 150 s |
| RAMP UP | | |
| Ramp-up rate (T_L to T_P) | 3 °C/s maximum | |
| Liquidus temperature (T_L) | 183 °C | 217 °C |
| Time (t_L) maintained above T_L | 60 s to 150 s | |
| Peak package body temperature (T_P) max. | 235 °C | 260 °C |
| Time (t_P) within 5 °C of the peak max. temperature | 20 s | 30 s |
| RAMP DOWN | | |
| Ramp-down rate (T_P to T_L) | 6 °C/s maximum | |
| Time from 25 °C to peak temperature | 6 min maximum | 8 min maximum |

PAD DIMENSIONS in inches [millimeters]

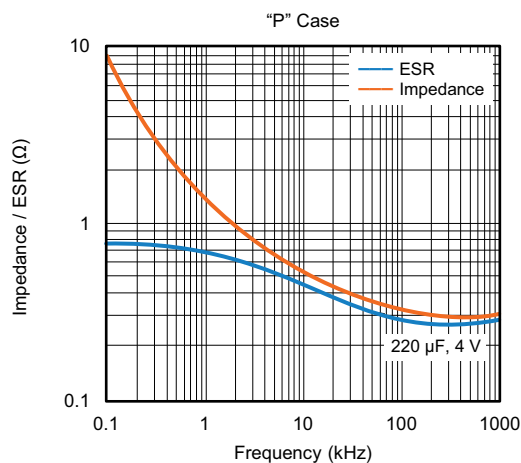
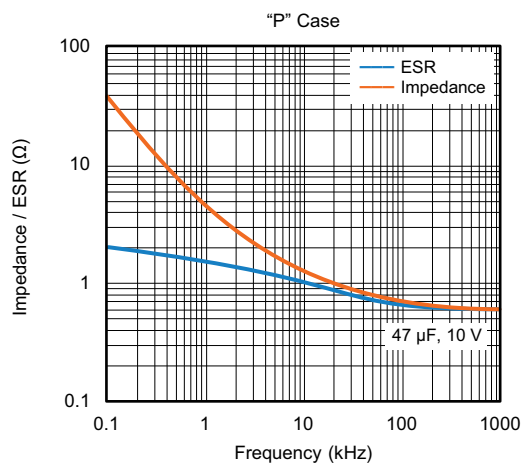
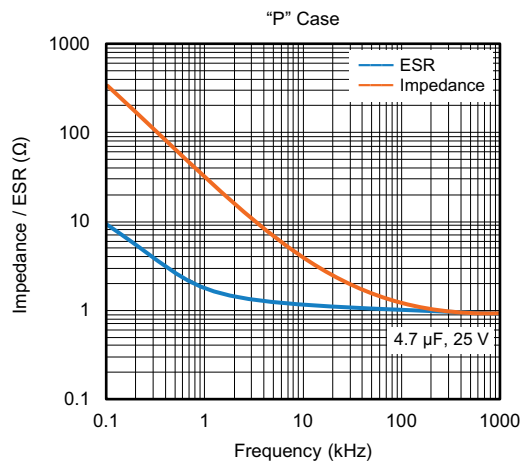
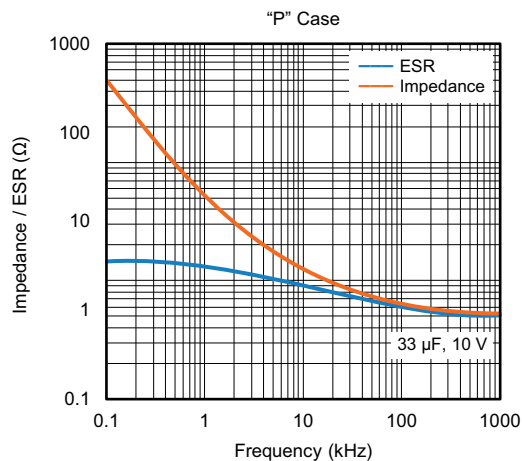


| CASE CODE | A (NOM.) | B (MIN.) | C (NOM.) | D (MIN.) |
|-----------|--------------|--------------|--------------|--------------|
| K | 0.021 [0.53] | 0.016 [0.41] | 0.022 [0.55] | 0.054 [1.37] |
| M, G | 0.024 [0.61] | 0.027 [0.70] | 0.025 [0.64] | 0.080 [2.03] |
| R, W9, S | 0.035 [0.89] | 0.029 [0.74] | 0.041 [1.05] | 0.099 [2.52] |
| W | 0.035 [0.89] | 0.029 [0.74] | 0.037 [0.95] | 0.095 [2.41] |
| P | 0.035 [0.89] | 0.029 [0.74] | 0.054 [1.37] | 0.112 [2.84] |
| A, Q, A0 | 0.047 [1.19] | 0.042 [1.06] | 0.065 [1.65] | 0.148 [3.76] |
| B, B0 | 0.094 [2.39] | 0.044 [1.11] | 0.072 [1.82] | 0.159 [4.03] |
| N, T | 0.094 [2.39] | 0.044 [1.11] | 0.065 [1.65] | 0.152 [3.86] |
| M2 | 0.315 [8.00] | 0.098 [2.50] | 0.197 [5.00] | 0.394 [10.0] |

TYPICAL CURVES AT +25 °C, IMPEDANCE AND ESR VS. FREQUENCY



TYPICAL CURVES AT +25 °C, IMPEDANCE AND ESR VS. FREQUENCY





GUIDE TO APPLICATION

1. **AC Ripple Current:** the maximum allowable ripple current shall be determined from the formula:

$$I_{RMS} = \sqrt{\frac{P}{R_{ESR}}}$$

where,

P = power dissipation in watts at +25 °C (see paragraph number 5 and the table Power Dissipation as given in the tables in the product datasheets)

R_{ESR} = the capacitor equivalent series resistance at the specified frequency

2. **AC Ripple Voltage:** the maximum allowable ripple voltage shall be determined from the formula:

$$V_{RMS} = Z \sqrt{\frac{P}{R_{ESR}}}$$

or, from the formula:

$$V_{RMS} = I_{RMS} \times Z$$

where,

P = power dissipation in watts at +25 °C (see paragraph number 5 and the table Power Dissipation as given in the tables in the product datasheets)

R_{ESR} = the capacitor equivalent series resistance at the specified frequency

Z = the capacitor impedance at the specified frequency

- 2.1 The sum of the peak AC voltage plus the applied DC voltage shall not exceed the DC voltage rating of the capacitor.
- 2.2 The sum of the negative peak AC voltage plus the applied DC voltage shall not allow a voltage reversal exceeding 10 % of the DC working voltage at +25 °C.
3. **Reverse Voltage:** these capacitors are capable of withstanding peak voltages in the reverse direction equal to 10 % of the DC rating at +25 °C, 5 % of the DC rating at +25 °C, 5 % of the DC rating at +85 °C, and 1 % of the DC rating at +125 °C.
4. **Temperature Derating:** if these capacitors are to be operated at temperatures above +25 °C, the permissible RMS ripple current shall be calculated using the derating factors as shown:

| TEMPERATURE | DERATING FACTOR |
|-------------|-----------------|
| +25 °C | 1.0 |
| +85 °C | 0.9 |
| +125 °C | 0.4 |

5. **Power Dissipation:** power dissipation will be affected by the heat sinking capability of the mounting surface. Non-sinusoidal ripple current may produce heating effects which differ from those shown. It is important that the equivalent I_{RMS} value be established when calculating permissible operating levels. (Power Dissipation calculated using +25 °C temperature rise.)

6. **Printed Circuit Board Materials:** molded capacitors are compatible with commonly used printed circuit board materials (alumina substrates, FR4, FR5, G10, PTFE-fluorocarbon and porcelainized steel).

7. **Attachment:**

- 7.1 **Solder Paste:** the recommended thickness of the solder paste after application is 0.007" ± 0.001" [0.178 mm ± 0.025 mm]. Care should be exercised in selecting the solder paste. The metal purity should be as high as practical. The flux (in the paste) must be active enough to remove the oxides formed on the metallization prior to the exposure to soldering heat. In practice this can be aided by extending the solder preheat time at temperatures below the liquidous state of the solder.

- 7.2 **Soldering:** capacitors can be attached by conventional soldering techniques; vapor phase, convection reflow, infrared reflow, wave soldering and hot plate methods. The Soldering Profile charts show recommended time / temperature conditions for soldering. Preheating is recommended. The recommended maximum ramp rate is 3 °C per second. Attachment with a soldering iron is not recommended due to the difficulty of controlling temperature and time at temperature. The soldering iron must never come in contact with the capacitor. For details see www.vishay.com/doc?40214.

- 7.2.1 **Backward and Forward Compatibility:** capacitors with SnPb or 100 % tin termination finishes can be soldered using SnPb or lead (Pb)-free soldering processes.

8. **Cleaning (Flux Removal) After Soldering:** molded capacitors are compatible with all commonly used solvents such as TES, TMS, Prelete, Chloroethane, Terpene and aqueous cleaning media. However, CFC / ODS products are not used in the production of these devices and are not recommended. Solvents containing methylene chloride or other epoxy solvents should be avoided since these will attack the epoxy encapsulation material.

- 8.1 When using ultrasonic cleaning, the board may resonate if the output power is too high. This vibration can cause cracking or a decrease in the adherence of the termination. DO NOT EXCEED 9W/l at 40 kHz for 2 min.

9. **Recommended Mounting Pad Geometries:** proper mounting pad geometries are essential for successful solder connections. These dimensions are highly process sensitive and should be designed to minimize component rework due to unacceptable solder joints. The dimensional configurations shown are the recommended pad geometries for both wave and reflow soldering techniques. These dimensions are intended to be a starting point for circuit board designers and may be fine tuned if necessary based upon the peculiarities of the soldering process and / or circuit board design.



Solid Tantalum Chip Capacitors MICROTAN[®] High Reliability Leadframeless Molded Capacitors TM8 and DLA 11020

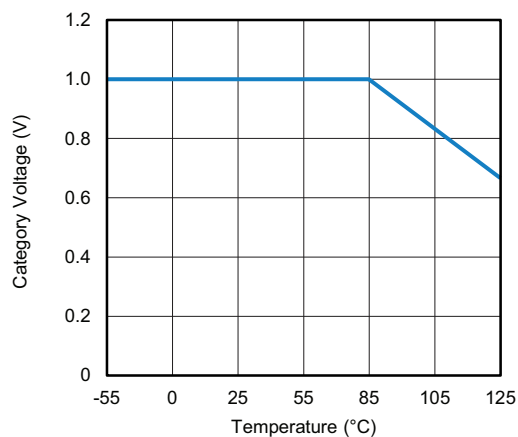
| ELECTRICAL PERFORMANCE CHARACTERISTICS | | | | |
|--|---|---------------|------------------|---------------|
| ITEM | PERFORMANCE CHARACTERISTICS | | | |
| Category temperature range | -55 °C to +85 °C (to +125 °C with voltage derating) | | | |
| Capacitance tolerance | ± 20 %, ± 10 %, tested via bridge method, at 25 °C, 120 Hz | | | |
| Dissipation factor | Limits per Standard Ratings table. Tested via bridge method, at 25 °C, 120 Hz. | | | |
| ESR | Limits per Standard Ratings table. Tested via bridge method, at 25 °C, 100 kHz. | | | |
| Leakage current | After application of rated voltage applied to capacitors for 5 min using a steady source of power with 1 k Ω resistor in series with the capacitor under test, leakage current at 25 °C is not more than described in Standard Ratings table. <i>Note that the leakage current varies with temperature and applied voltage. See graph below for the appropriate adjustment factor.</i> | | | |
| Reverse voltage | Capacitors are capable of withstanding peak voltages in the reverse direction equal to: 10 % of the DC rating at +25 °C 5 % of the DC rating at +85 °C 1 % of the DC rating at +125 °C Vishay does not recommend intentional or repetitive application of reverse voltage. | | | |
| Ripple current and Temperature derating | For maximum permissible ripple current (I_{RMS}) or/and voltage (V_{RMS}) please refer to product datasheet and Guide to Application. If capacitors are to be used at temperatures above +25 °C, the permissible RMS ripple current or voltage shall be calculated using the derating factors: 1.0 at +25 °C 0.9 at +85 °C 0.4 at +125 °C | | | |
| Maximum operating and surge voltages vs. temperature | +85 °C | | +125 °C | |
| | RATED VOLTAGE | SURGE VOLTAGE | CATEGORY VOLTAGE | SURGE VOLTAGE |
| | V | V | V | V |
| | 2.0 | 2.6 | 1.3 | 1.7 |
| | 4.0 | 5.2 | 2.7 | 3.4 |
| | 6.3 | 8.0 | 4.0 | 5.0 |
| | 10 | 13 | 7.0 | 8.0 |
| | 16 | 20 | 10 | 12 |
| | 20 | 26 | 13 | 16 |
| | 25 | 32 | 17 | 20 |
| | 35 | 46 | 23 | 28 |
| | 40 | 52 | 26 | 31 |

Notes

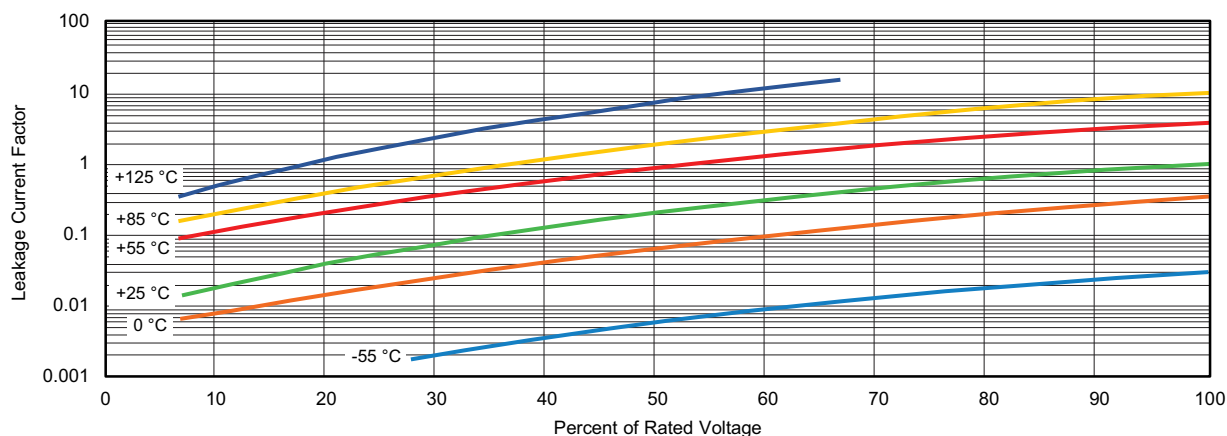
- All information presented in this document reflects typical performance characteristics
- For information about recommended voltage derating see: www.vishay.com/doc?40246
- For temperatures above +85 °C the voltage derating ratio should be applied with respect to category voltage, namely: up to +85 °C: category voltage = rated voltage; at +125 °C: category voltage = 2/3 of rated voltage, between these temperatures it decreases linearly - see graph "Category to Rated Voltage Ratio vs. Operating Temperature"



CATEGORY VOLTAGE VS. TEMPERATURE



TYPICAL LEAKAGE CURRENT TEMPERATURE FACTOR



Notes

- At +25 °C, the leakage current shall not exceed the value listed in the Standard Ratings table.
- At +85 °C, the leakage current shall not exceed 10 times the value listed in the Standard Ratings table.
- At +125 °C, the leakage current shall not exceed 12 times the value listed in the Standard Ratings table



| ENVIRONMENTAL AND MECHANICAL PERFORMANCE CHARACTERISTICS | | |
|--|--|---|
| ITEM | CONDITION | POST TEST PERFORMANCE |
| Vibration | In accordance with MIL-PRF-55365 | In accordance with MIL-PRF-55365 (as for style CWR15) |
| Thermal shock | | |
| Resistance to solder heat | | |
| Moisture resistance | | |
| Stability at low and high temperatures | | |
| Surge voltage | | |
| Life test | | |
| Solderability | | |
| Resistance to solvents | | |
| Terminal strength/ Shear stress test | Method: AEC-Q200-006, conditions: Pressure load of 5 N for 10 s \pm 1 s | There shall be no mechanical or visual damage and the components shall meet the original electrical requirements. |
| Flammability | Encapsulation materials meet UL 94 V-0 with an oxygen index of 32 %. | |

Note

- All measurements to be performed after 24 h conditioning at room temperature.



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